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Stocking Distributor

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Vishay/Siliconix SI4228DY-T1-E3

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Si4228DY-T1-E3

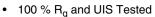
Vishay Siliconix

Dual N-Channel 25 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$ $I_{D}(A)^{a, e}$ Q_{g}					
	0.018 at V _{GS} = 10 V	8				
25	0.020 at V _{GS} = 4.5 V	8	7.8 nC			
	0.024 at V _{GS} = 2.5 V	7.5				

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^{a, e}	Q _g (Typ.)			
	0.018 at $V_{GS} = 10 \text{ V}$	8				
25	0.020 at $V_{GS} = 4.5 \text{ V}$	8	7.8 nC			
	0.024 at V _{GS} = 2.5 V	7.5				

FEATURES TrenchFET® Power MOSFET

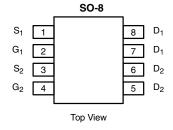


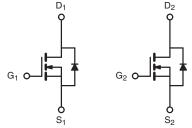
Compliant to RoHS Directive 2002/95/EC



APPLICATIONS

- Synchronous Buck Converter
- DC/DC Converter





N-Channel MOSEET

N-Channel MOSFET

Ordering Information: Si4228DY-T1-E3 (Lead (Pb)-free)

ABSOLUTE MAXIMUM RATIN	IGS (T _A = 25 °C	, unless oth	erwise noted)	
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V _{DS}	25	V
Gate-Source Voltage		V_{GS}	± 12	v
	T _C = 25 °C		8 ^e	
Continuous Prain Current /T 150 °C)	T _C = 70 °C	1 .	8 ^e	
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	- I _D	8 ^{b, c, e}	
	T _A = 70 °C		6.9 ^{b, c}	A
Pulsed Drain Current		I _{DM}	50	^
Continuous Source-Drain Diode Current	T _C = 25 °C	I _S	2.6	
Continuous Source-Drain Diode Current	T _A = 25 °C		1.7 ^{b, c}	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	15	
Avalanche Energy		E _{AS}	11.25	mJ
	T _C = 25 °C		3.1	
Maximum Dawar Dissination	T _C = 70 °C	P _D	2	w
Maximum Power Dissipation	T _A = 25 °C		2 ^{b, c}	VV
	T _A = 70 °C		1.3 ^{b, c}	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	52	62.5	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	30	40			

Notes:

- a. Based on $T_C = 25$ °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under steady state conditions is 110 °C/W.
- e. Package limited.

Document Number: 67908 S11-0653-Rev. A, 11-Apr-11

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Datasheet of SI4228DY-T1-E3 - MOSFET 2N-CH 25V 8A 8SO

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Si4228DY-T1-E3

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	•		l		'		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	25			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050 A		20		mV/°(
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 3.2			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu\text{A}$	0.6		1.4	٧	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA	
Zana Cata Valtana Busin Comment		V _{DS} = 25 V, V _{GS} = 0 V			1	, . A	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 25 V, V _{GS} = 0 V, T _J = 55 °C			10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α	
	, ,	V _{GS} = 10 V, I _D = 7 A		0.015	0.018	8	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 7 \text{ A}$		0.016	0.020		
	, ,	$V_{GS} = 2.5 \text{ V}, I_D = 5 \text{ A}$		0.020	0.024	1	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 7 A		68		S	
Dynamic ^b			L		L		
Input Capacitance	C _{iss}			790		pF	
Output Capacitance	C _{oss}	V _{DS} = 12.5 V, V _{GS} = 0 V, f = 1 MHz		146			
Reverse Transfer Capacitance	C _{rss}			76			
·		V _{DS} = 12.5 V, V _{GS} = 10 V, I _D = 8.6 A		16.5	25		
Total Gate Charge	Q_g	3.2		7.8	12	nC	
Gate-Source Charge	Q _{gs}	V _{DS} = 12.5 V, V _{GS} = 4.5 V, I _D = 8.6 A		1.6			
Gate-Drain Charge	Q _{gd}			1.7			
Gate Resistance	R _g	f = 1 MHz	0.5	2.5	5	Ω	
Turn-On Delay Time	t _{d(on)}			7	14		
Rise Time	t _r	$V_{DD} = 12.5 \text{ V, R}_{L} = 1.8 \Omega$		12	18		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 6.9 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		21	30		
Fall Time	t _f	•		10	20		
Turn-On Delay Time	t _{d(on)}			4	8	ns	
Rise Time	t _r	$V_{DD} = 12.5 \text{ V, R}_{L} = 1.8 \Omega$		9	18		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 6.9 \text{ A}, V_{GEN} = 10 \text{ V}, R_q = 1 \Omega$		20	30		
Fall Time	t _f			7	14		
Drain-Source Body Diode Characterist			l		L		
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			2.6		
Pulse Diode Forward Current ^a	I _{SM}	<u> </u>			50	Α	
Body Diode Voltage	V _{SD}	I _S = 6.9 A		0.82	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			15	23	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			6	12	nC	
Reverse Recovery Fall Time	t _a	$I_F = 6.9 \text{ A, dI/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 ^{\circ}\text{C}$		8			
Reverse Recovery Rise Time	t _b			7		ns	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing.

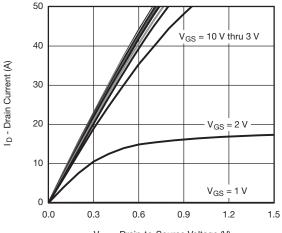




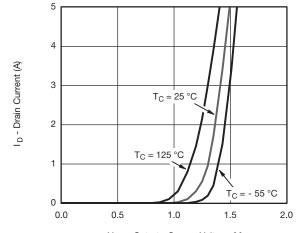
Si4228DY-T1-E3

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

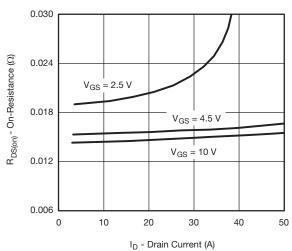


 V_{DS} - Drain-to-Source Voltage (V)

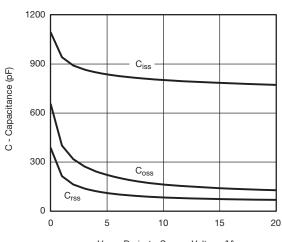


V_{GS} - Gate-to-Source Voltage (V) **Transfer Characteristics**

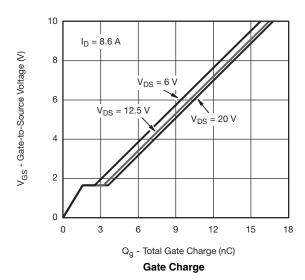


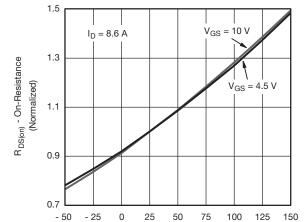


On-Resistance vs. Drain Current and Gate Voltage



V_{DS} - Drain-to-Source Voltage (V) Capacitance





T_J - Junction Temperature (°C) On-Resistance vs. Junction Temperature

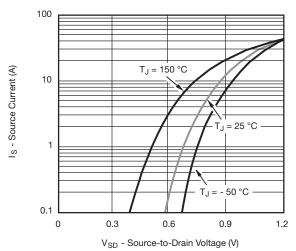
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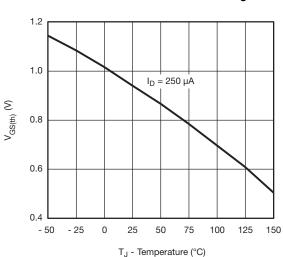
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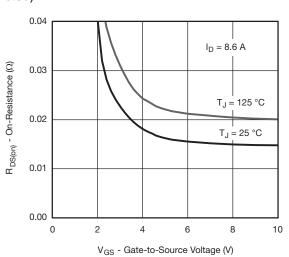
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



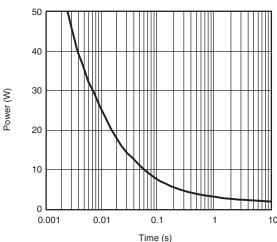
Source-Drain Diode Forward Voltage



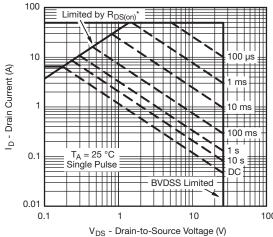
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient

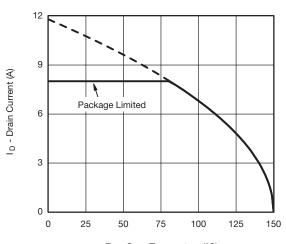




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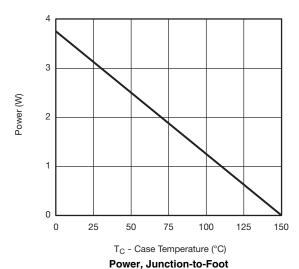
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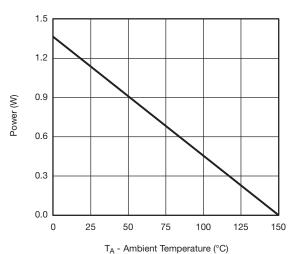
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



$T_{\mbox{\scriptsize C}}$ - Case Temperature (°C)

Current Derating*





Power, Junction-to-Ambient

Document Number: 67908 www.vishay.com S11-0653-Rev. A, 11-Apr-11 5

 $^{^{\}star}$ The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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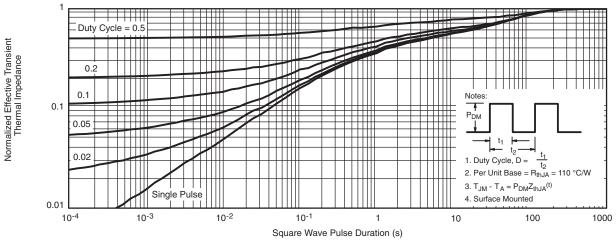
Datasheet of SI4228DY-T1-E3 - MOSFET 2N-CH 25V 8A 8SO

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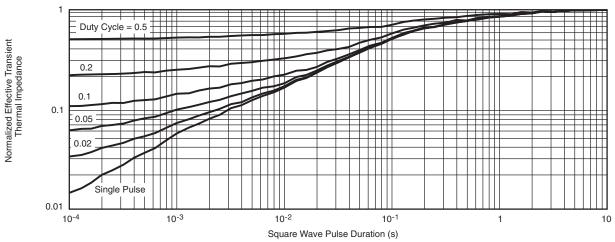
Si4228DY-T1-E3

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations.

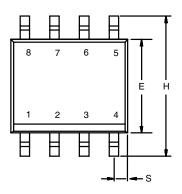


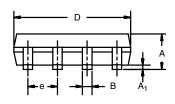


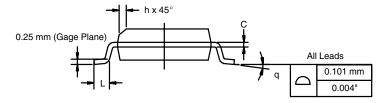
Package Information

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SOIC (NARROW): 8-LEADJEDEC Part Number: MS-012







	MILLIM	IETERS	INC	HES	
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
Е	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
FCN: C-06527-Rev L 11-Sep-06					

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498

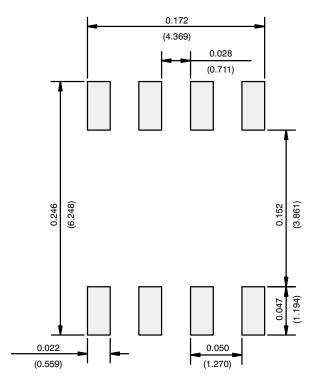
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Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

APPLICATION NOT

Document Number: 72606 Revision: 21-Jan-08



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Datasheet of SI4228DY-T1-E3 - MOSFET 2N-CH 25V 8A 8SO

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